

FCA20N60 N-Channel SuperFET[®] MOSFET 600 V, 20 A, 190 mΩ

Features

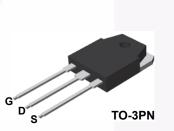
- 650V @ T_{.I} = 150°C
- Typ. R_{DS(on)} = 150 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 75 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 165 pF)
- 100% Avalanche Tested

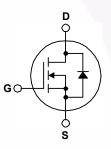
Applications

- Solar Inverter
- AC-DC Power Supply

Description

SuperFET[®] MOSFET is Fairchild Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low onresistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

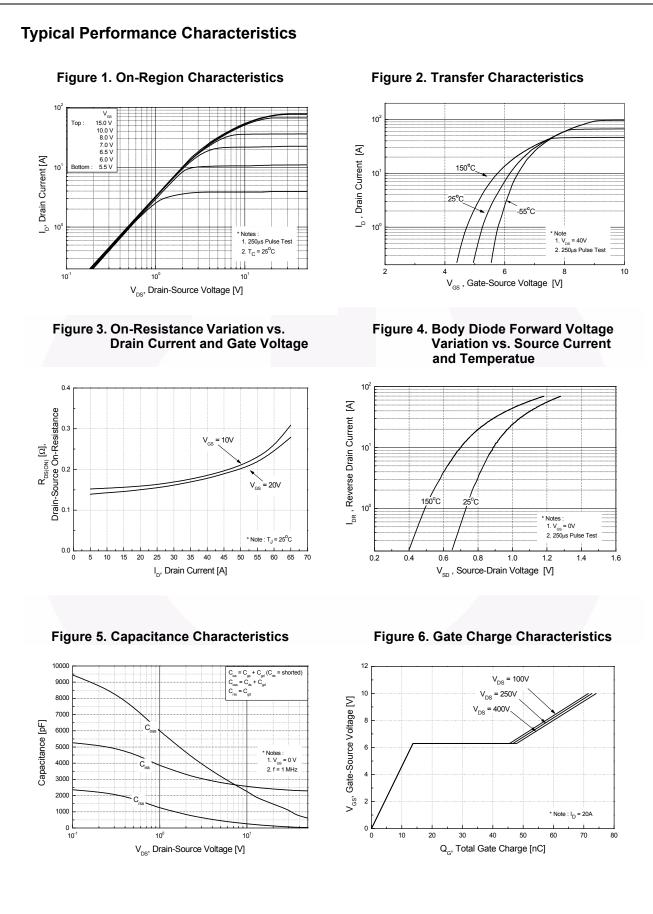
Symbol		FCA20N60 / FCA20N60_F109	Unit			
V _{DSS}	Drain to Source Voltage	Drain to Source Voltage				
V _{GSS}	Gate-Soure voltage			±30	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		20		
	Drain Current	- Continuous ($T_C = 100^{\circ}C$)		12.5	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	60	А	
E _{AS}	Single Pulsed Avalanche Energy (N			690	mJ	
I _{AR}	Avalanche Current		(Note 1)	20	А	
E _{AR}	Repetitive Avalanche En	ergy	(Note 1)	20.8	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)			4.5	V/ns	
P _D	David Dia dia attan	$(T_{C} = 25^{\circ}C)$		208	W	
	Power Dissipation	- Derate Above 25°C		1.67	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

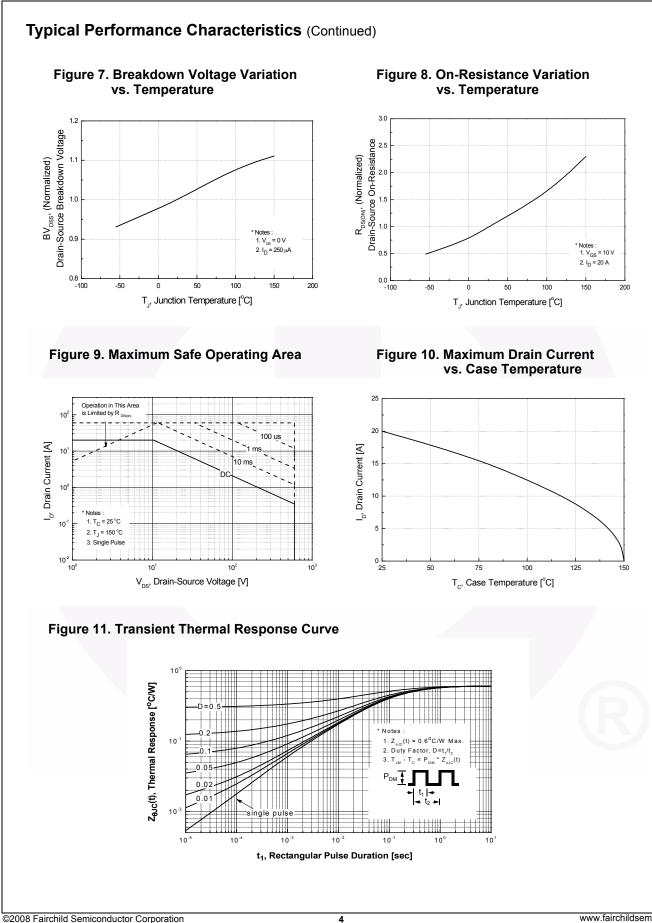
Thermal Characteristics

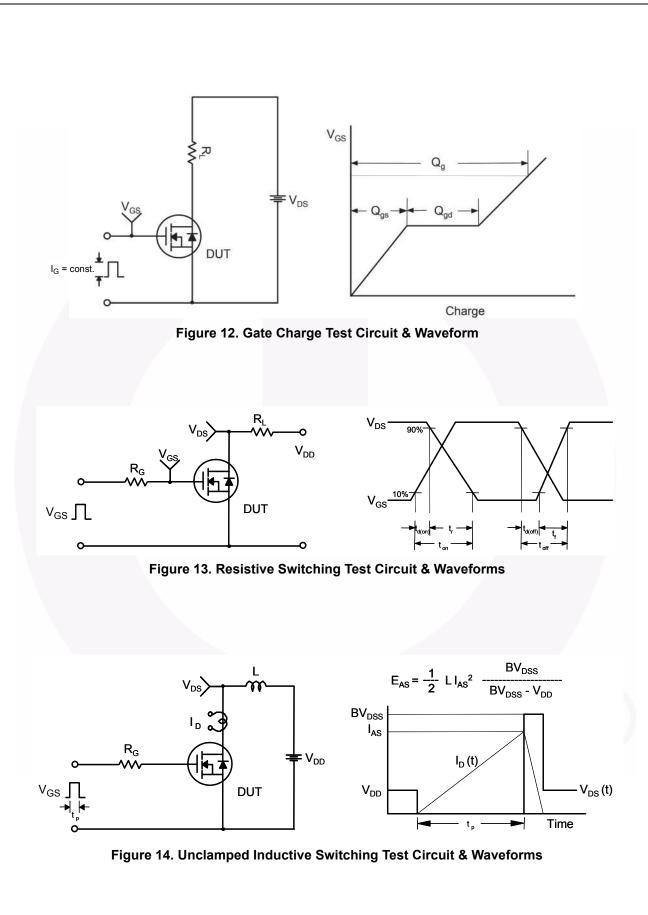
Symbol	Parameter	FCA20N60 / FCA20N60_F109	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.6	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	41.7	°C/W

Part Number		Top Mark	Package	Packing Method	Reel Size	Тар	e Width	Qua	ntity
FCA20	N60	FCA20N60	TO-3PN	Tube	N/A		N/A	30 units	
		TO-3PN	PN Tube N/A		N/A		30 units		
Electrica	l Char	acteristics T _C = 25°	C unless c	therwise noted.					
Symbol		Parameter		Test Conditio	ons	Min.	Тур.	Max.	Uni
Off Charac	teristic	S							
27.4			I	_D = 250 μA, V _{GS} = 0 V,	T _J = 25 ^o C	600	-	-	V
3V _{DSS}			<u> </u>	_D = 250 μA, V _{GS} = 0 V,	-	-	650	-	V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient			_D = 250 μA, Reference		-	0.6	-	V/ºC
3V _{DS}	Drain-Source Avalanche Breakdown Voltage		'n ۱	V _{GS} = 0 V, I _D = 20 A		÷	700	-	V
	Zero Gr	Zero Gate Voltage Drain Current		$V_{\rm DS}$ = 600 V, $V_{\rm GS}$ = 0 V		1		1	
I _{DSS} Zero Gate Volta		ale voltage Dialli Cuitelli	١	$V_{DS} = 480 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$		-	-	10	μA
GSS	Gate to	Gate to Body Leakage Current		$V_{\rm GS}$ = ±30 V, V _{DS} = 0 V		-	-	±100	nA
On Charac	teristic	5							
√ _{GS(th)}	Gate Th	reshold Voltage	١	V _{GS} = V _{DS} , I _D = 250 μA		3.0	-	5.0	V
R _{DS(on)}	Static D	Static Drain to Source On Resistance		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		-	0.15	0.19	Ω
FS	Forward Transconductance		Y	V _{DS} = 40 V, I _D = 10 A		-	17	-	S
Dynamic C	haracte	eristics							
C _{iss}	-	apacitance				- 1	2370	3080	pF
Soss	Output (Output Capacitance Reverse Transfer Capacitance		V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		-	1280	1665	pF
						-	95	-	pF
C _{oss}	Output	utput Capacitance		V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz		-	65	85	pF
Poss(eff.)	Effective	Effective Output Capacitance		$V_{DS} = 0 V \text{ to } 400 V, V_{GS} = 0 V$		-	165	-	pF
λ_{q}	Total Ga	Total Gate Charge at 10V		V _{DS} = 480 V, I _D = 20 A, V _{GS} = 10 V		-	75	98	nC
λ _{gs}	Gate to Source Gate Charge					-	13.5	18	nC
λ _{gd}	Gate to	ate to Drain "Miller" Charge			(Note 4)	-	36	-	nC
Switching	Charac	teristics							
d(on)	Turn-Or	Turn-On Delay Time Turn-On Rise Time		V_{DD} = 300 V, I _D = 20 A, V _{GS} = 10 V, R _G = 25 Ω (Note 4)		-	62	135	ns
r	Turn-Or					-	140	290	ns
t _{d(off)} Turn-Off Delay Tir		Delay Time				-	230	470	ns
f	Turn-Off Fall Time					-	65	140	ns
)rain-Sou	rce Dioo	le Characteristics							
s		m Continuous Drain to Sou	rce Diode I	Forward Current		-	-	20	A
s SM	Maximum Pulsed Drain to Source Diode					-	-	60	A
sm / _{SD}		Drain to Source Diode Forward Voltage		$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 20 \text{ A}$		-	-	1.4	V
rr	Reverse Recovery Time			$V_{GS} = 0 V, I_{SD} = 20 A,$		-	530		ns
	Reverse Recovery Charge			$dI_{F}/dt = 100 A/\mu s$		-	10.5		μC

3: $I_{SD} \le 20 \text{ A}$, di/dt $\le 200 \text{ A}/\mu s$, $V_{DD} \le BV_{DSS}$, starting $T_J = 25^{\circ}\text{C}$. 4: Essentially independent of operating temperature typical characteristics. FCA20N60 — N-Channel SuperFET[®] MOSFET

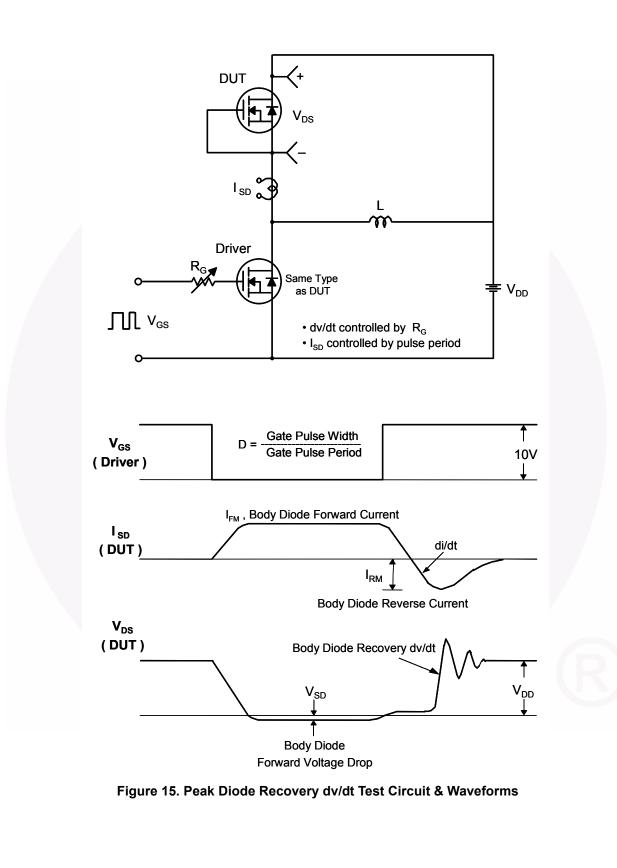


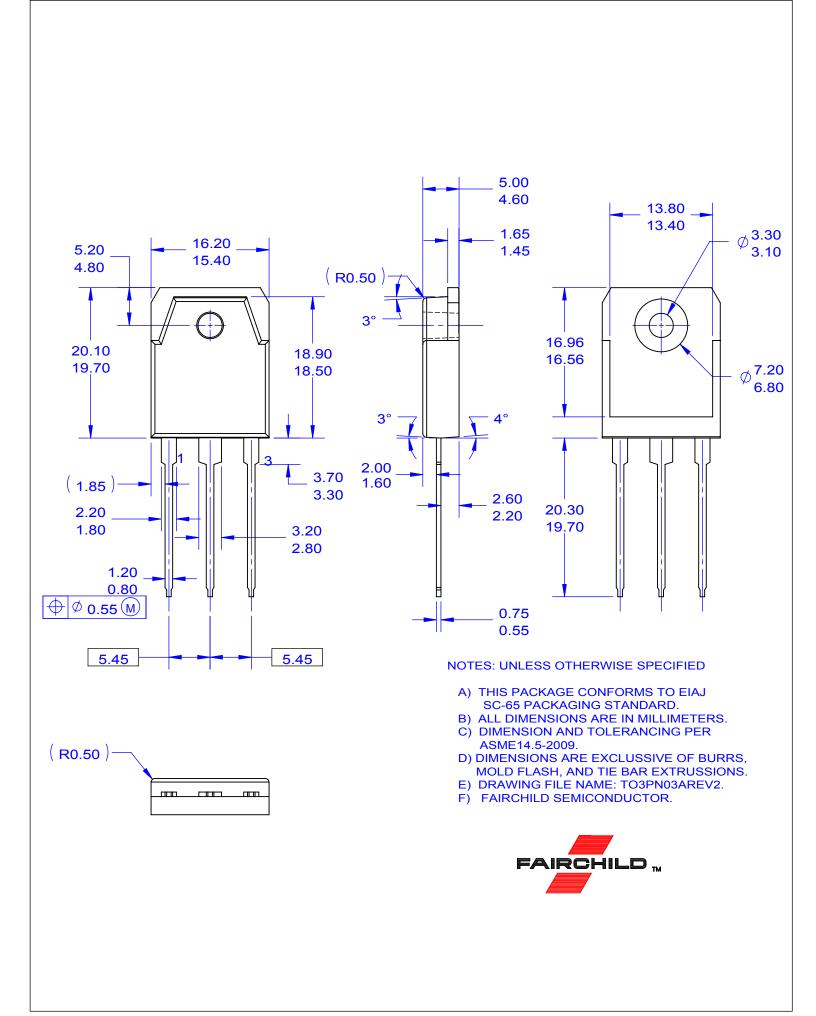


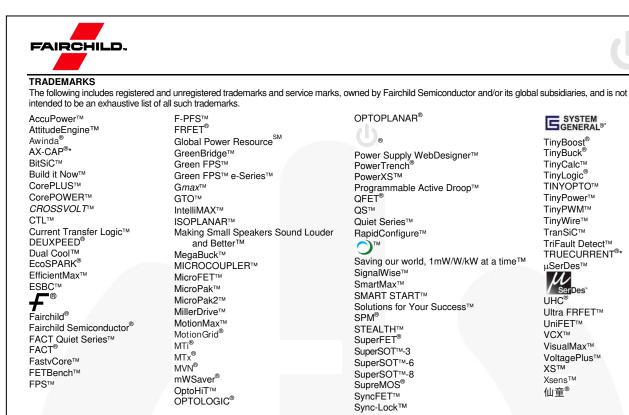


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